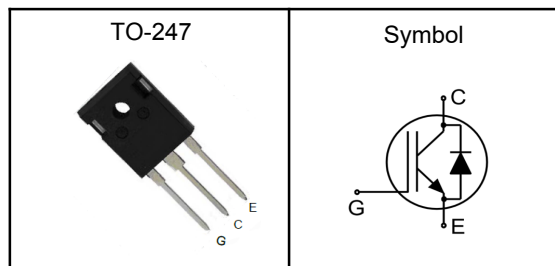


650V/60A Trench FS II Fast IGBT
Features

- Trench FS II Technology
- Very low $V_{CE(sat)}$
- High speed switching
- ROHS Compliant

Applications

- Inverter welding machine
- Motor drives
- UPS

Pin Description


| | | |
|-------------------|-----|---|
| V_{CES} | 650 | V |
| $V_{CE(sat)-Typ}$ | 1.7 | V |
| I_C | 75 | A |

Absolute Maximum Ratings ($T_C=25^\circ\text{C}$, Unless Otherwise Noted)

| Parameter | Symbol | Rating | Units |
|---------------------------------------|-----------|------------|------------------|
| Collector-Emitter Voltage | V_{CES} | 650 | V |
| Gate- Emitter Voltage | V_{GES} | ± 25 | V |
| Collector Current ¹ | I_C | 150 | A |
| Collector Current ¹ | I_C | 75 | A |
| Pulsed Collector Current ² | I_{CM} | 225 | A |
| Diode Continuous Forward Current | I_F | 75 | A |
| Diode Pulsed Forward Current | I_{FM} | 225 | A |
| Power Dissipation | P_D | 416 | W |
| Power Dissipation | P_D | 208 | W |
| Storage Temperature Range | T_{STG} | -55 to 175 | $^\circ\text{C}$ |
| Operating Junction Temperature Range | T_J | -55 to 175 | $^\circ\text{C}$ |

Thermal Characteristics

| Parameter | Symbol | Typ | Max | Unit |
|-----------------------------------------------|------------------|-----|------|--------------------|
| Thermal Resistance Junction-Ambient | $R_{\theta JA}$ | --- | 40 | $^\circ\text{C/W}$ |
| Thermal Resistance Junction to case for IGBT | $R_{\theta JC}$ | --- | 0.36 | $^\circ\text{C/W}$ |
| Thermal Resistance Junction to case for Diode | $R_{\theta JCD}$ | --- | 0.41 | $^\circ\text{C/W}$ |



650V/60A Trench FS II Fast IGBT

Electrical Characteristics ($T_J=25^{\circ}\text{C}$, Unless Otherwise Noted)

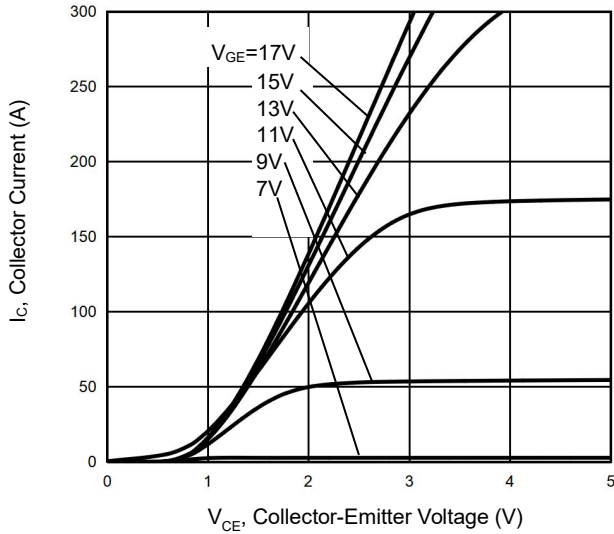
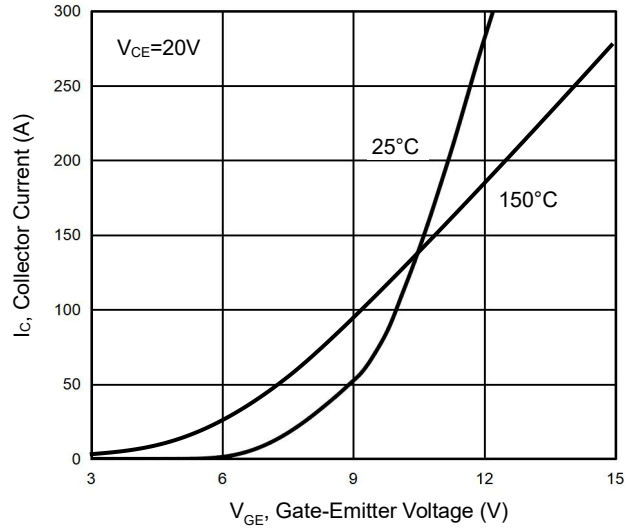
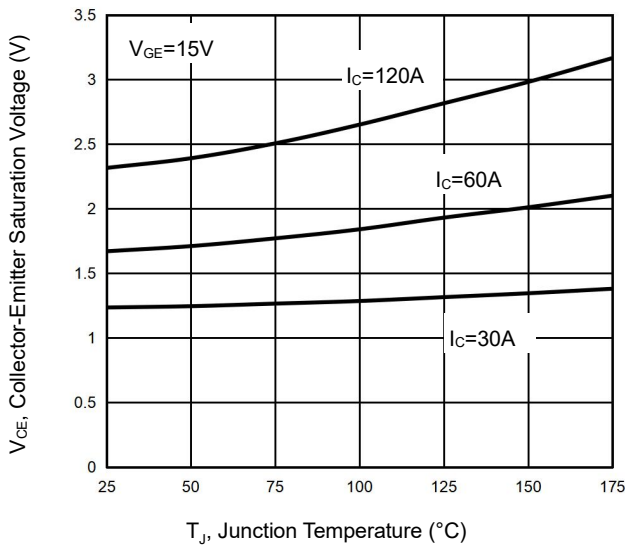
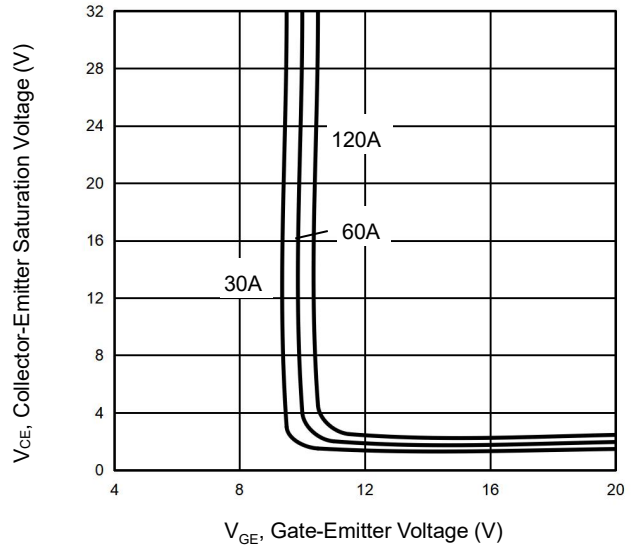
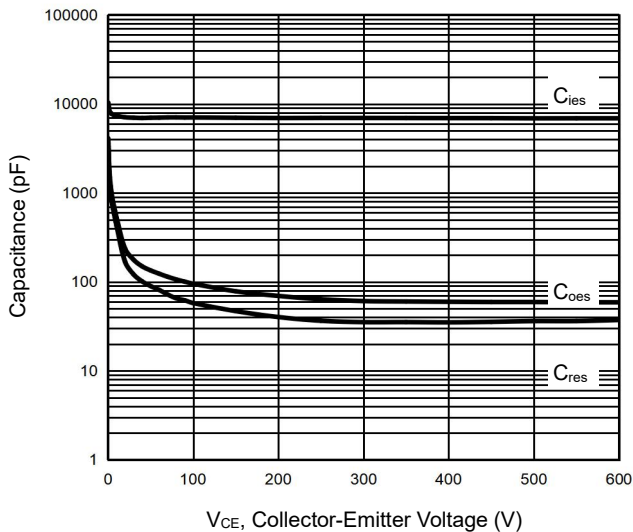
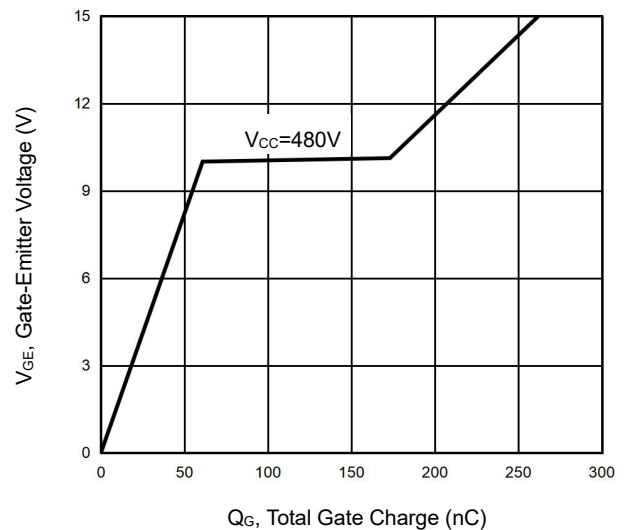
| Parameter | Symbol | Conditions | Min | Typ | Max | Unit | |
|--------------------------------------|---------------|--------------------------------------------------------------------------|---------------------------|------|----------|---------|---|
| Collector-Emitter Breakdown Voltage | BV_{CES} | $V_{GE}=0V, I_C=250\mu A$ | 650 | --- | --- | V | |
| Collector-Emitter Saturation Voltage | $V_{CE(sat)}$ | $V_{GE}=15V, I_C=75A,$ | $T_J=25^{\circ}\text{C}$ | --- | 1.7 | --- | V |
| | | | $T_J=175^{\circ}\text{C}$ | --- | 2.2 | --- | V |
| Gate Threshold Voltage | $V_{GE(th)}$ | $V_{CE}=V_{GE}, I_C=1mA$ | 5.5 | 6.0 | 6.5 | V | |
| Collector-Emitter Leakage Current | I_{CES} | $V_{CE}=650V, V_{GE}=0V$ | --- | --- | 1 | μA | |
| Gate to Emitter Leakage Current | I_{GES} | $V_{GE}=\pm V, V_{CE}=0V$ | --- | --- | ± 00 | nA | |
| Total Gate Charge | Q_g | $V_{CE}=400V, V_{GE}=15V, I_C=75A$ | --- | 285 | --- | nC | |
| Gate to Emitter Charge | Q_{ge} | | --- | 58 | --- | nC | |
| Gate to Collector Charge | Q_{gc} | | --- | 96 | --- | nC | |
| Turn-On Delay Time | $t_{d(ON)}$ | $V_{CE}=400V, I_C=75A, V_{GE}=15V, R_g=10\Omega, \text{ Inductive Load}$ | --- | 60 | --- | ns | |
| Rise Time | t_r | | --- | 160 | --- | | |
| Turn-Off Delay Time | $t_{d(off)}$ | | --- | 274 | --- | | |
| Fall Time | t_f | | --- | 134 | --- | mJ | |
| Turn-On Switching Loss | E_{on} | | --- | 3.85 | --- | | |
| Turn-Off Switching Loss | E_{off} | | --- | 0.9 | --- | | |
| Total Switching Loss | E_{ts} | --- | 2.0 | --- | | | |
| Input Capacitance | C_{ies} | $V_{CE}=25V, V_{GE}=0V, f=1MHz$ | --- | 7020 | --- | pF | |
| Output Capacitance | C_{oes} | | --- | 198 | --- | | |
| Reverse Transfer Capacitance | C_{res} | | --- | 130 | --- | | |

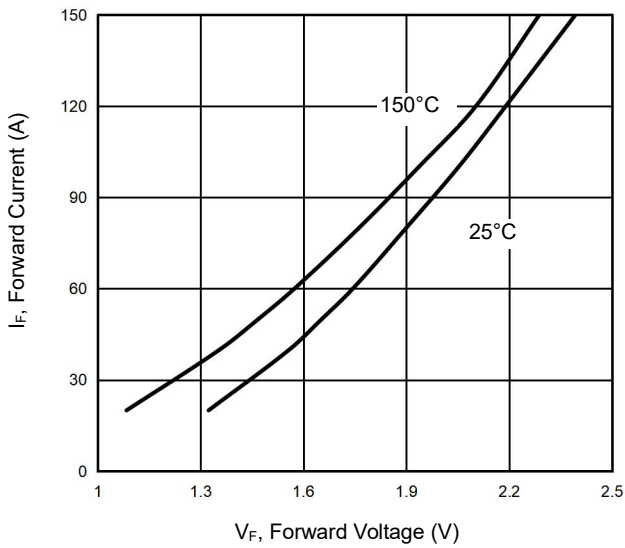
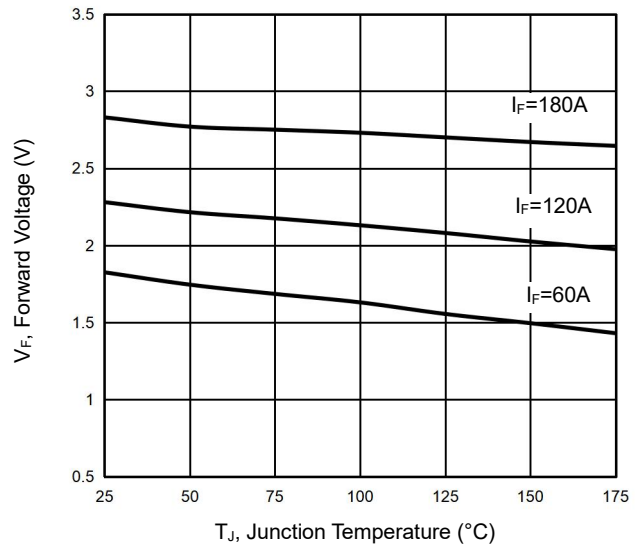
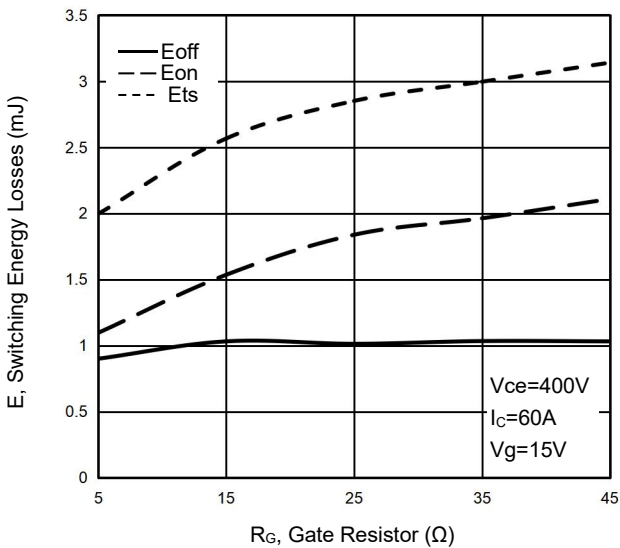
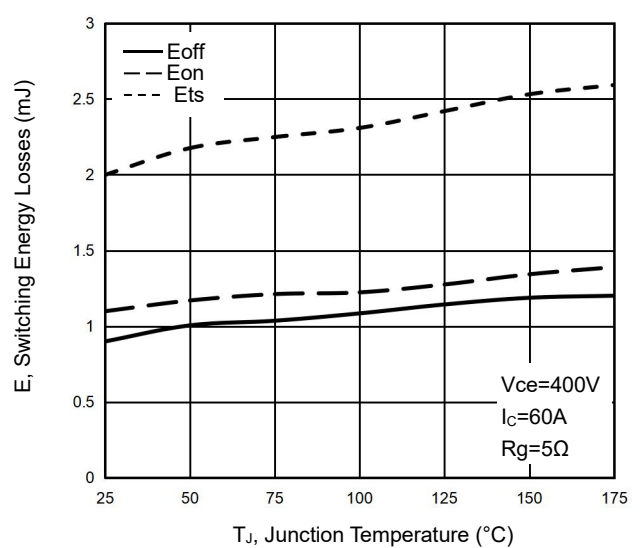
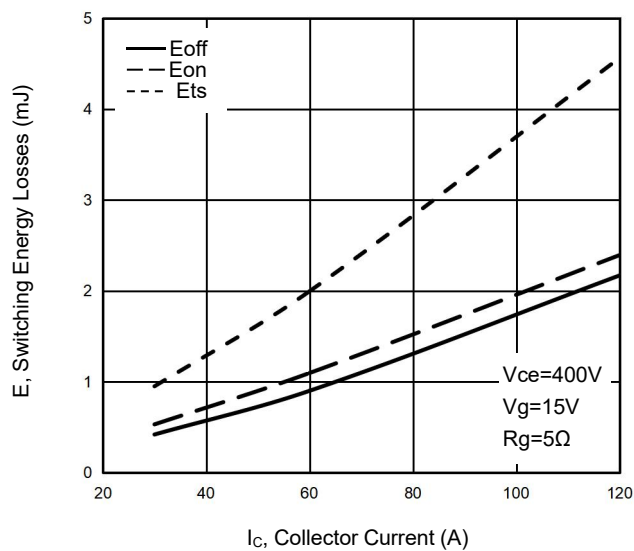
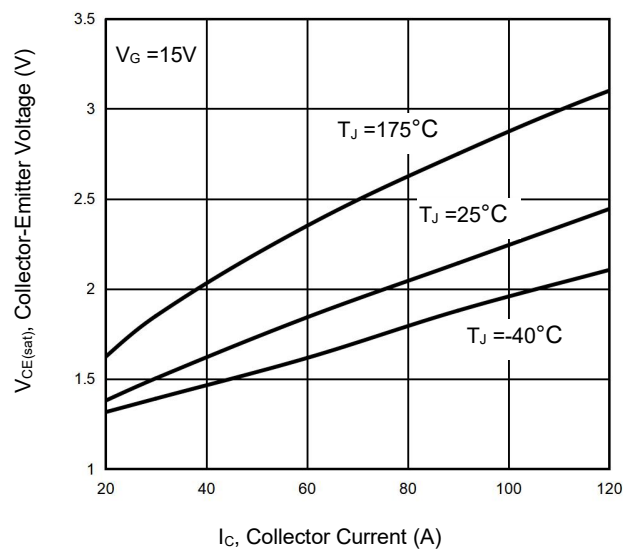
Drain-Source Diode Characteristics

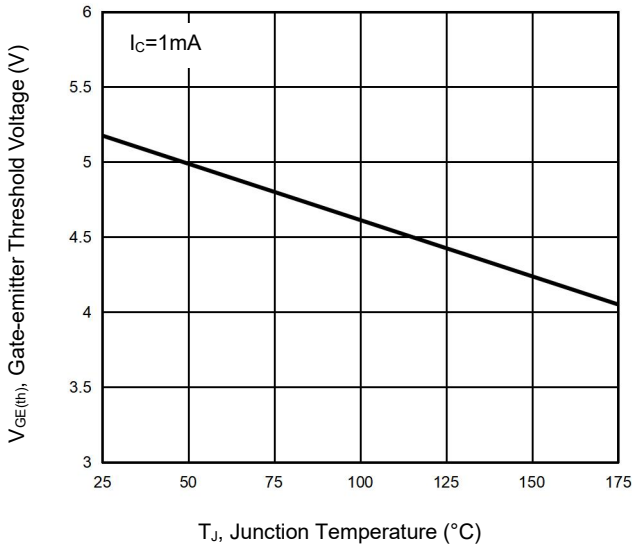
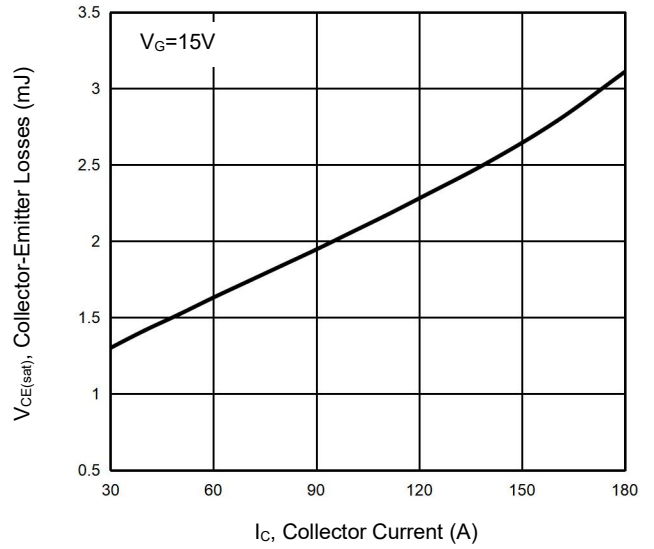
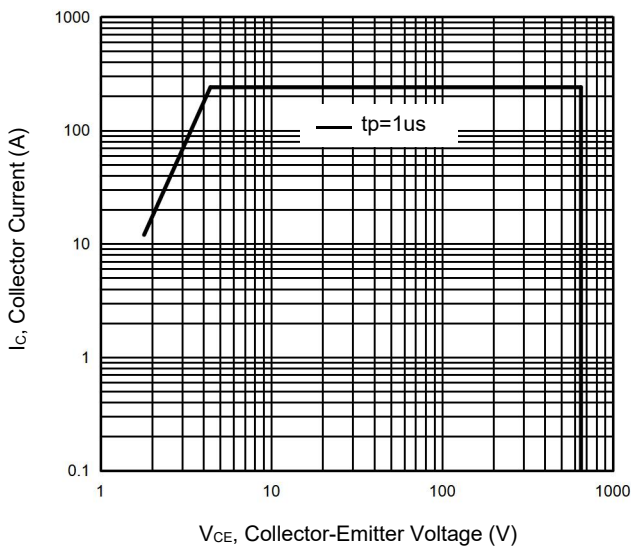
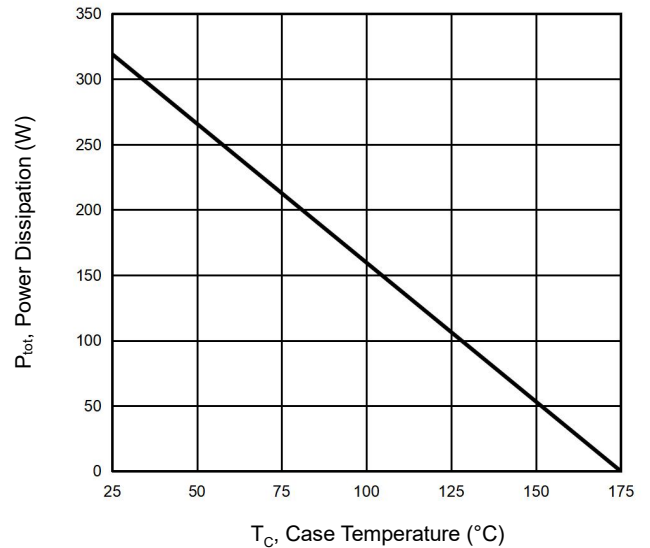
| Parameter | Symbol | Conditions | Min | Typ | Max | Unit |
|-------------------------------------|-----------|-----------------------------------------------------|-----|-----|-----|---------|
| Diode Forward Voltage | V_F | $I_F=60A, T_C=25^{\circ}\text{C}$ | --- | 1.7 | 2.4 | V |
| Reverse Recovery Time | t_{rr} | $I_F=60A, di/dt=200A/\mu s, T_C=25^{\circ}\text{C}$ | --- | 186 | --- | nS |
| Reverse Recovery Charge | Q_{rr} | | --- | 0.3 | --- | μC |
| Diode Peak Reverse Recovery Current | I_{rrm} | | --- | 3.8 | --- | A |

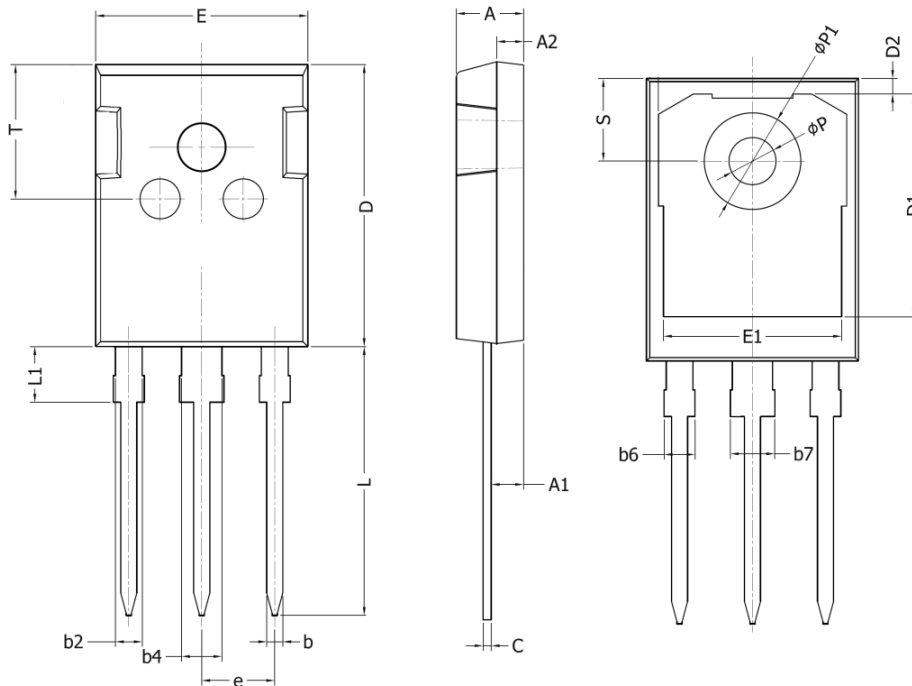
Note:

- 1.The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
- 2.The data tested by pulsed , pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$

650V/60A Trench FS II Fast IGBT
Typical Characteristics
Figure 1 Output Characteristics

Figure 2 Transfer Characteristics

Figure 3 V_{CEsat} vs. Case Temperature

Figure 4 Saturation Voltage vs. V_{GE}

Figure 5 Capacitance Characteristics

Figure 6 Gate Charge Wave Form


650V/60A Trench FS II Fast IGBT
Figure 7 Forward Characteristics

Figure 8 V_F vs. Temperature

Figure 9 Switching Loss vs. R_G

Figure 10 Switching Energy vs. Temperature

Figure 11 Switching Loss vs. Collector Current

Figure 12 $V_{CE(sat)}$ vs. Collector Current


650V/60A Trench FS II Fast IGBT
Figure 13 $V_{GE(th)}$ vs. Junction Temperature

Figure 14 $V_{CE(SAT)}$ vs. Collector Current

Figure 15 Forward Bias Safe Operating Area

Figure 16 P_{tot} vs. Case Temperature


650V/60A Trench FS II Fast IGBT
TO-247 Package Outline Dimensions


| Symbol | Dimensions In Millimeters | |
|--------|---------------------------|-------|
| | Min. | Max. |
| A | 4.90 | 5.20 |
| A1 | 2.31 | 2.51 |
| A2 | 1.9 | 2.1 |
| b | 1.16 | 1.26 |
| b2 | 1.96 | 2.06 |
| b4 | 2.96 | 3.06 |
| b6 | - | 2.25 |
| b7 | - | 3.25 |
| C | 0.59 | 0.66 |
| D | 20.90 | 21.20 |
| D1 | 16.25 | 16.85 |
| D2 | 1.05 | 1.35 |
| E | 15.75 | 16.10 |
| E1 | 13.00 | 13.60 |
| e | 5.436 BSC | |
| L | 19.80 | 20.20 |
| L1 | - | 4.30 |
| P | 3.40 | 3.60 |
| P1 | 7.00 | 7.40 |
| S | 6.05 | 6.25 |
| T | 9.80 | 10.20 |